

## Long Side Termination Thick Film Chip Resistors



### FEATURES

- Enhanced power rating
- Long side terminations
- Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q200 qualified



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### STANDARD ELECTRICAL SPECIFICATIONS

| MODEL      | SIZE |          | RATED DISSIPATION<br>$P_{70}$<br>W | LIMITING ELEMENT VOLTAGE<br>$U_{max. AC/DC}$<br>V | TEMPERATURE COEFFICIENT<br>ppm/K | TOLERANCE<br>% | RESISTANCE RANGE<br>$\Omega$ | SERIES   |
|------------|------|----------|------------------------------------|---------------------------------------------------|----------------------------------|----------------|------------------------------|----------|
|            | INCH | METRIC   |                                    |                                                   |                                  |                |                              |          |
| RCL0612 e3 | 0612 | RR 1632M | 0.5                                | 75                                                | $\pm 100$                        | $\pm 1$        | 1R0 to 1M                    | E24; E96 |
|            |      |          |                                    |                                                   | $\pm 200$                        | $\pm 5$        |                              | E24      |
| RCL1218 e3 | 1218 | RR 3246M | 1.0                                | 200                                               | $\pm 100$                        | $\pm 1$        | 1R0 to 2.2M                  | E24; E96 |
|            |      |          |                                    |                                                   | $\pm 200$                        | $\pm 5$        |                              | E24      |
| RCL1225 e3 | 1225 | RR 3263M | 2.0 <sup>(1)</sup>                 | 200                                               | $\pm 100$                        | $\pm 1$        | 1R0 to 1M                    | E24; E96 |
|            |      |          |                                    |                                                   | $\pm 200$                        | $\pm 5$        |                              | E24      |

#### Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
  - Marking: See datasheet "Surface Mount Resistor Marking" (document number 20020).
  - Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.
- <sup>(1)</sup> Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

### TECHNICAL SPECIFICATIONS

| DESCRIPTION                                  | UNIT               | RCL0612       | RCL1218 | RCL1225            |
|----------------------------------------------|--------------------|---------------|---------|--------------------|
| Rated Dissipation $P_{70}$ <sup>(2)</sup>    | W                  | 0.5           | 1.0     | 2.0 <sup>(3)</sup> |
| Limiting Element Voltage<br>$U_{max. AC/DC}$ | V                  | 75            | 200     | 200                |
| Insulation Voltage $U_{ins}$ (1 min)         | V                  | > 100         | > 300   | > 300              |
| Insulation Resistance                        | $\Omega$           | > $10^9$      |         |                    |
| Category Temperature Range                   | $^{\circ}\text{C}$ | - 55 to + 155 |         |                    |
| Weight                                       | mg                 | 11            | 29.5    | 55                 |

#### Notes

- <sup>(2)</sup> The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155  $^{\circ}\text{C}$  is not exceeded.
- <sup>(3)</sup> Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

## PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: RCL061210K0FKEA

R C L 0 6 1 2 1 0 K 0 F K E A 0 0

| MODEL/SIZE                    | RESISTANCE                                                  | TOLERANCE                                    | TCR                                                      | PACKAGING                  | SPECIAL                         |
|-------------------------------|-------------------------------------------------------------|----------------------------------------------|----------------------------------------------------------|----------------------------|---------------------------------|
| RCL0612<br>RCL1218<br>RCL1225 | R = Decimal<br>K = Thousand<br>M = Million<br>0000 = Jumper | F = $\pm 1\%$<br>J = $\pm 5\%$<br>Z = Jumper | K = $\pm 100$ ppm/K<br>N = $\pm 200$ ppm/K<br>0 = Jumper | EA<br>EB<br>EC<br>EK<br>EG | Up to 2 digits<br>00 = Standard |

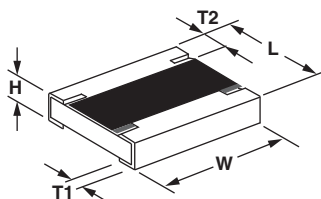
PRODUCT DESCRIPTION: RCL0612 100 10K 1% ET1 e3

| RCL0612                                | 100                                       | 10K                                                                                         | 1%                                  | ET1                                          | e3                                                 |
|----------------------------------------|-------------------------------------------|---------------------------------------------------------------------------------------------|-------------------------------------|----------------------------------------------|----------------------------------------------------|
| MODEL<br>RCL0612<br>RCL1218<br>RCL1225 | TCR<br>$\pm 100$ ppm/K<br>$\pm 200$ ppm/K | RESISTANCE<br>10R = 10 $\Omega$<br>10K = 10 k $\Omega$<br>1M = 1 M $\Omega$<br>0R0 = Jumper | TOLERANCE<br>$\pm 1\%$<br>$\pm 5\%$ | PACKAGING<br>ET1<br>ET5<br>ET6<br>ET9<br>E67 | LEAD (Pb)-FREE<br>e3 = Pure tin termination finish |

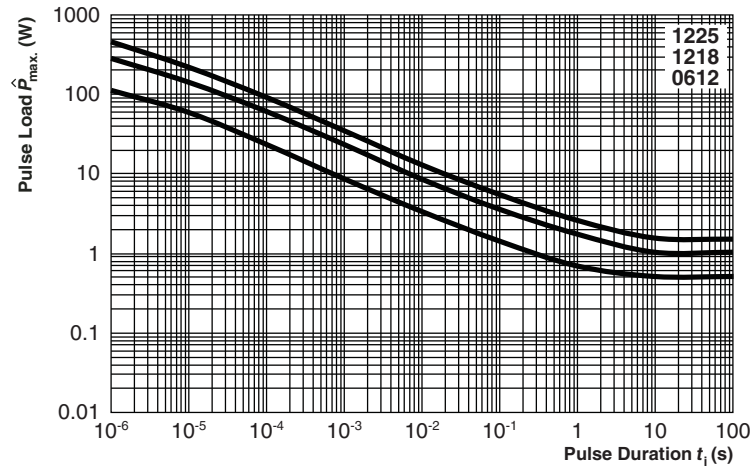
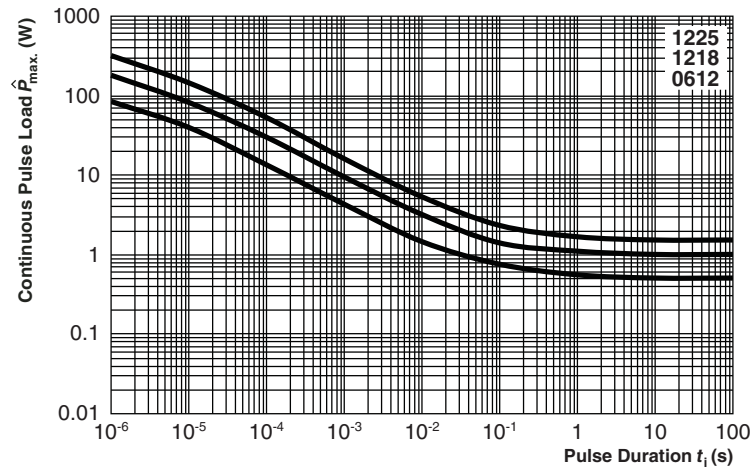
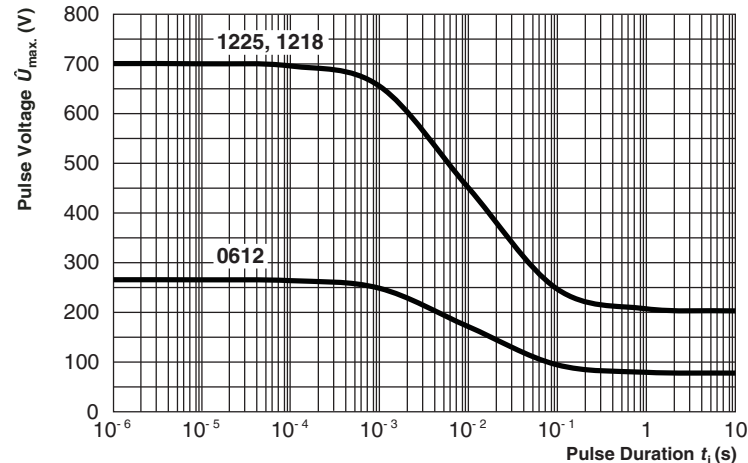
## PACKAGING

| MODEL   | UNIT          | PAPER TAPE ON REEL<br>ACC. TO IEC 60286-3, TYPE I |             |               | BLISTER TAPE ON REEL<br>ACC. TO IEC 60286-3, TYPE II |             |               |
|---------|---------------|---------------------------------------------------|-------------|---------------|------------------------------------------------------|-------------|---------------|
|         |               | QUANTITY                                          | PART NUMBER | PRODUCT DESC. | QUANTITY                                             | PART NUMBER | PRODUCT DESC. |
| RCL0612 | 180 mm/7"     | 5000                                              | EA          | ET1           |                                                      |             |               |
|         | 285 mm/11.25" | 10 000                                            | EB          | ET5           |                                                      |             |               |
|         | 330 mm/13"    | 20 000                                            | EC          | ET6           |                                                      |             |               |
| RCL1218 | 180 mm/7"     |                                                   |             |               | 4000                                                 | EK          | ET9           |
| RCL1225 | 180 mm/7"     |                                                   |             |               | 2000                                                 | EG          | E67           |

## DIMENSIONS in millimeters



| SIZE |        | DIMENSIONS             |                |                 |                 |                 | SOLDER PAD DIMENSIONS |     |     |                |     |     |
|------|--------|------------------------|----------------|-----------------|-----------------|-----------------|-----------------------|-----|-----|----------------|-----|-----|
|      |        |                        |                |                 |                 |                 | REFLOW SOLDERING      |     |     | WAVE SOLDERING |     |     |
| INCH | METRIC | L                      | W              | H               | T1              | T2              | a                     | b   | l   | a              | b   | l   |
| 0612 | 1632   | 1.6 $\pm$ 0.2          | 3.2 $\pm$ 0.2  | 0.55 $\pm$ 0.1  | 0.35 $\pm$ 0.15 | 0.25 $\pm$ 0.15 | 0.6                   | 3.2 | 1.0 | 1.1            | 3.2 | 1.0 |
| 1218 | 3246   | 3.2 $^{+0.10}_{-0.20}$ | 4.6 $\pm$ 0.15 | 0.55 $\pm$ 0.05 | 0.45 $\pm$ 0.2  | 0.4 $\pm$ 0.2   | 1.1                   | 4.9 | 1.9 | 1.25           | 4.8 | 1.9 |
| 1225 | 3263   | 3.2 $\pm$ 0.2          | 6.3 $\pm$ 0.2  | 0.75 $\pm$ 0.15 | 0.8 $\pm$ 0.2   | 0.4 $\pm$ 0.2   | 1.9                   | 7.6 | 1.2 | 1.9            | 7.6 | 1.2 |

**FUNCTIONAL PERFORMANCE**
**Single Pulse**

**Continuous Pulse**

**Pulse Voltage**


## Derating



## TEST PROCEDURES AND REQUIREMENTS

| EN<br>60115-1<br>CLAUSE |                       | IEC<br>60068-2<br>TEST<br>METHOD | TEST                                                                                                                | PROCEDURE                                                                              | REQUIREMENTS<br>PERMISSIBLE CHANGE ( $\Delta R$ ) |  |
|-------------------------|-----------------------|----------------------------------|---------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|---------------------------------------------------|--|
|                         |                       |                                  |                                                                                                                     |                                                                                        | STABILITY CLASS 2 OR BETTER                       |  |
|                         |                       |                                  | Stability for product types:                                                                                        | 1 $\Omega$ to 2.2 M $\Omega$                                                           |                                                   |  |
|                         |                       |                                  | RCL e3                                                                                                              |                                                                                        |                                                   |  |
| 4.5                     | -                     | Resistance                       | -                                                                                                                   | $\pm 1 \%$                                                                             | $\pm 5 \%$                                        |  |
| 4.7                     | -                     | Voltage proof                    | $U = 1.4 \times U_{\text{ins}}$ ; 60 s                                                                              | No flashover or breakdown                                                              |                                                   |  |
| 4.13                    | -                     | Short time overload              | $U = 2.5 \times \sqrt{P_{70} \times R}$<br>$\leq 2 \times U_{\text{max.}}$ ;<br>Duration acc. to style              | $\pm (0.25 \% R + 0.05 \Omega)$                                                        | $\pm (0.5 \% R + 0.05 \Omega)$                    |  |
| 4.17.2                  | 58 (Td)               | Solderability                    | Solder bath method;<br>Sn60Pb40<br>non activated flux;<br>(235 $\pm$ 5) $^{\circ}\text{C}$<br>(2 $\pm$ 0.2) s       | Good tinning ( $\geq 95 \%$ covered);<br>no visible damage                             |                                                   |  |
|                         |                       |                                  | Solder bath method;<br>Sn96.5Ag3Cu0.5<br>non-activated flux;<br>(245 $\pm$ 5) $^{\circ}\text{C}$<br>(3 $\pm$ 0.3) s | Good tinning ( $\geq 95 \%$ covered);<br>no visible damage                             |                                                   |  |
| 4.8.4.2                 | -                     | Temperature<br>coefficient       | (20/- 55/20) $^{\circ}\text{C}$ and<br>(20/125/20) $^{\circ}\text{C}$                                               | $\pm 100 \text{ ppm/K}$                                                                | $\pm 200 \text{ ppm/K}$                           |  |
| 4.32                    | 21 (Uu <sub>3</sub> ) | Shear<br>(adhesion)              | 45N                                                                                                                 | No visible damage                                                                      |                                                   |  |
| 4.33                    | 21 (Uu <sub>1</sub> ) | Substrate bending                | Depth 2 mm;<br>3 times                                                                                              | No visible damage, no open circuit in bent position<br>$\pm (0.25 \% R + 0.05 \Omega)$ |                                                   |  |
| 4.19                    | 14 (Na)               | Rapid change of<br>temperature   | 30 min at - 55 $^{\circ}\text{C}$ ;<br>30 min at 125 $^{\circ}\text{C}$                                             |                                                                                        |                                                   |  |
|                         |                       |                                  | 5 cycles                                                                                                            | $\pm (0.25 \% R + 0.05 \Omega)$                                                        | $\pm (0.5 \% R + 0.05 \Omega)$                    |  |
|                         |                       |                                  | 1000 cycles                                                                                                         | $\pm (1 \% R + 0.05 \Omega)$                                                           | $\pm (1 \% R + 0.05 \Omega)$                      |  |

| TEST PROCEDURES AND REQUIREMENTS |                                  |                                                                  |                                                                                                                    |                                                                |                                                            |
|----------------------------------|----------------------------------|------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|------------------------------------------------------------|
| EN<br>60115-1<br>CLAUSE          | IEC<br>60068-2<br>TEST<br>METHOD | TEST                                                             | PROCEDURE                                                                                                          | REQUIREMENTS<br>PERMISSIBLE CHANGE ( $\Delta R$ )              |                                                            |
|                                  |                                  |                                                                  |                                                                                                                    | STABILITY CLASS 2 OR BETTER                                    |                                                            |
|                                  |                                  |                                                                  | Stability for product types:                                                                                       | 1 $\Omega$ to 2.2 M $\Omega$                                   |                                                            |
|                                  |                                  |                                                                  | RCL e3                                                                                                             |                                                                |                                                            |
| 4.23                             | -                                | Climatic sequence:                                               | -                                                                                                                  | $\pm (1 \% R + 0.05 \Omega)$                                   | $\pm (2 \% R + 0.1 \Omega)$                                |
| 4.23.2                           | 2 (Ba)                           | Dry heat                                                         | 125 °C; 16 h                                                                                                       |                                                                |                                                            |
| 4.23.3                           | 30 (Db)                          | Damp heat, cyclic                                                | 55 °C; $\geq 90 \% \text{ RH}$ ;<br>24 h; 1 cycle                                                                  |                                                                |                                                            |
| 4.23.4                           | 1 (Aa)                           | Cold                                                             | - 55 °C; 2 h                                                                                                       |                                                                |                                                            |
| 4.23.5                           | 13 (M)                           | Low air pressure                                                 | 1 kPa; (25 $\pm$ 10) °C; 1 h                                                                                       |                                                                |                                                            |
| 4.23.6                           | 30 (Db)                          | Damp heat, cyclic                                                | 55 °C; $\geq 90 \% \text{ RH}$ ;<br>24 h; 5 cycles                                                                 |                                                                |                                                            |
| 4.23.7                           | -                                | DC load                                                          | $U = \sqrt{P_{70}} \times R$                                                                                       |                                                                |                                                            |
| 4.25.1                           | -                                | Endurance<br>at 70 °C                                            | $U = \sqrt{P_{70}} \times R \leq U_{\text{max.}}$ ;<br>1.5 h on; 0.5 h off;<br>70 °C; 1000 h<br>70 °C; 8000 h      | $\pm (0.5 \% R + 0.05 \Omega)$<br>$\pm (1 \% R + 0.05 \Omega)$ | $\pm (2 \% R + 0.1 \Omega)$<br>$\pm (4 \% R + 0.1 \Omega)$ |
| 4.18.2                           | 58 (Td)                          | Resistance to<br>soldering heat                                  | Solder bath method<br>(260 $\pm$ 5) °C;<br>(10 $\pm$ 1) s                                                          | $\pm (0.25 \% R + 0.05 \Omega)$                                | $\pm (0.5 \% R + 0.05 \Omega)$                             |
| 4.35                             | -                                | Flamability,<br>needle flame test                                | IEC 60695-11-5;<br>10 s                                                                                            | No burning after 30 s                                          |                                                            |
| 4.24                             | 78 (Cab)                         | Damp heat,<br>steady state                                       | (40 $\pm$ 2) °C;<br>(93 $\pm$ 3) % RH;<br>56 days                                                                  | $\pm (1 \% R + 0.05 \Omega)$                                   |                                                            |
| 4.25.3                           | -                                | Endurance at<br>upper category<br>temperature                    | 155 °C, 1000 h                                                                                                     | $\pm (1 \% R + 0.05 \Omega)$                                   | $\pm (2 \% R + 0.1 \Omega)$                                |
| 4.40                             | -                                | Electrostatic<br>discharge<br>(Human Body Model)                 | IEC 61340-3-1<br>3 pos. + 3 neg.<br>discharges;<br>ESD voltage: 1000 V                                             | $\pm (1 \% R + 0.05 \Omega)$                                   |                                                            |
| 4.29                             | 45 (XA)                          | Component solvent<br>resistance                                  | Isopropyl alcohol;<br>50 °C; method 2                                                                              | No visible damage                                              |                                                            |
| 4.30                             | 45 (XA)                          | Solvent resistance<br>of marking                                 | Isopropyl alcohol;<br>50 °C; method 1,<br>toothbrush                                                               | Marking legible,<br>no visible damage                          |                                                            |
| 4.22                             | 6 (Fc)                           | Vibration, endurance<br>by sweeping                              | f = 10 Hz to 2000 Hz;<br>x, y, z $\leq$ 1.5 mm;<br>A $\leq$ 200 m/s <sup>2</sup> ;<br>10 sweeps per axis           | $\pm (0.25 \% R + 0.05 \Omega)$                                | $\pm (0.5 \% R + 0.05 \Omega)$                             |
| 4.37                             | -                                | Periodic electric<br>overload                                    | $U = \sqrt{15 \times P_{70} \times R}$<br>$\leq 2 \times U_{\text{max.}}$ ;<br>0.1 s on; 2.5 s off;<br>1000 cycles | $\pm (1 \% R + 0.05 \Omega)$                                   |                                                            |
| 4.27                             | -                                | Single pulse high<br>voltage overload,<br>10 $\mu$ s/700 $\mu$ s | $\hat{U} = 10 \times \sqrt{P_{70} \times R}$<br>$\leq 2 \times U_{\text{max.}}$ ;<br>10 pulses                     | $\pm (1 \% R + 0.05 \Omega)$                                   |                                                            |

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3



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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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